## MAZC062D

## Silicon planar type

### For surge absorption circuit

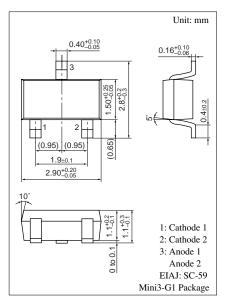
#### ■ Features

- Mini type 3-pin package(Mini3-G1)
- Low joint capacity zener diode ( $V_Z = 6.2 \text{ V}$ )
- Two anode-common element wiring

### ■ Absolute Maximum Ratings $T_a = 25$ °C

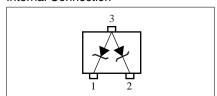
Parameter	Symbol	Rating	Unit
Repetitive peak forward current	$I_{FRM}$	200	mA
Total power dissipation*	P <sub>tot</sub>	200	mW
Junction temperature	$T_{j}$	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*: With a printed circuit board



Marking Symbol: 6.2C

#### Internal Connection



## ■ Electrical Characteristics $T_a = 25^{\circ}C^{*1}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 10 \text{ mA}$		0.9	1.0	V
Zener voltage*2	V <sub>Z</sub>	$I_Z = 5 \text{ mA}$	5.9		6.5	V
Zener knee operating resistance	R <sub>ZK</sub>	$I_Z = 0.5 \text{ mA}$			100	Ω
Zener operating resistance	R <sub>Z</sub>	$I_Z = 5 \text{ mA}$			30	Ω
Reverse current	$I_R$	$V_{R} = 5.5 \text{ V}$			3	μΑ
Terminal capacitance	Ct	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$		8		pF

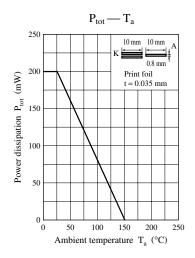
Note) 1. Rated input/output frequency: 5 MHz

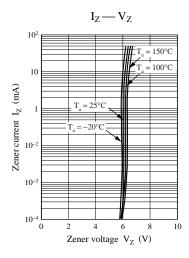
- 2. Test method according to the JIS C7031 testing
- 3. Electrostatic discharge is ±15 kV

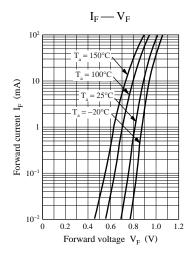
Test method: IEC-801 (C = 150 pF, R = 330  $\Omega$ , Contact discharge: 10 times)

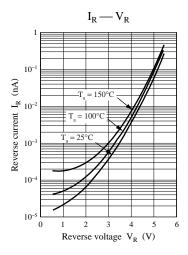
Test unit: ESS-200AX

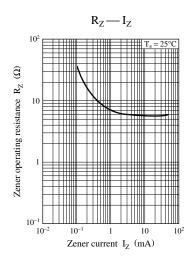
- 4. \*1: The  $V_Z$  value is for the temperature of 25°C. In other cases, carry out the temperature compensation.
  - \*2: Guaranteed at 20 ms after power application.

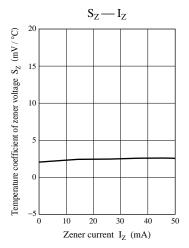


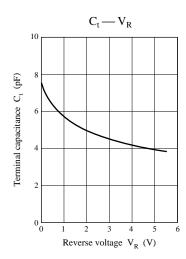












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